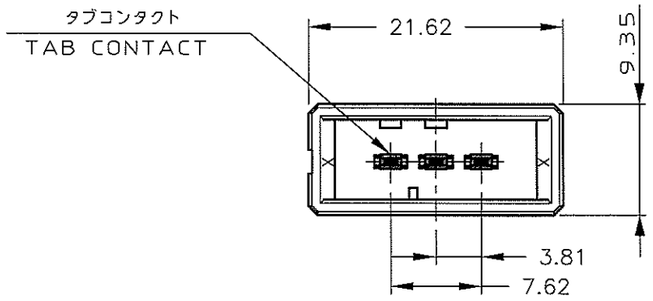
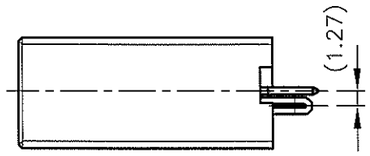
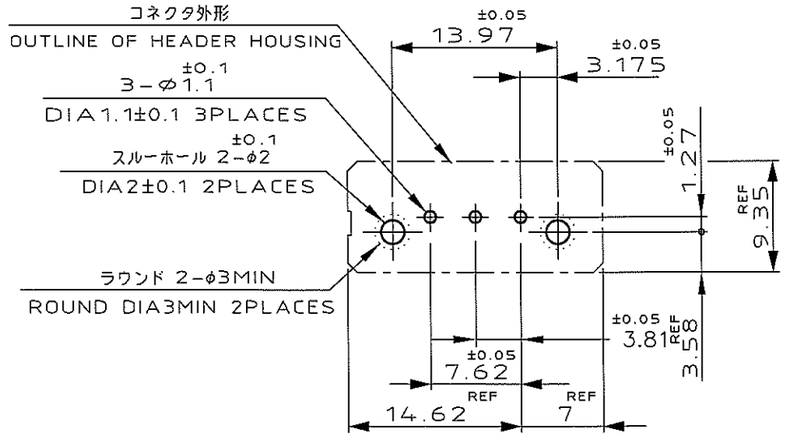
NUMBER 178313

3rd ANGLE PROJECTION

METRIC





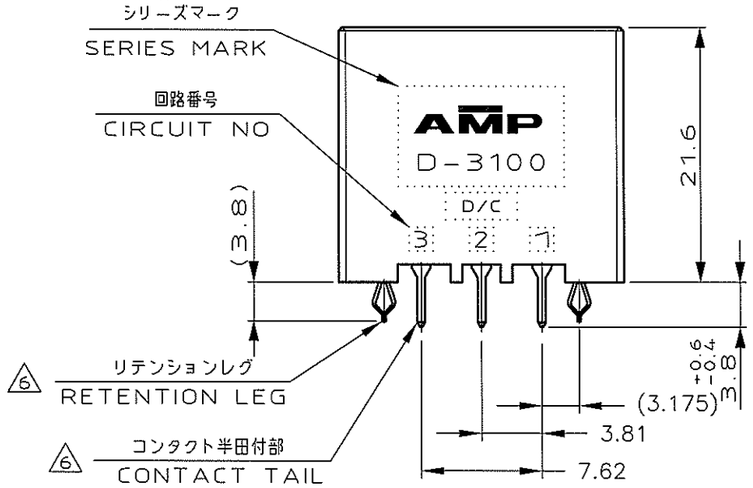


推奨基板取付け穴寸法

PC 基板厚：1.6±0.1
（非累積公差）
（コネクタ搭載面）

RECOMEND PC BOARD HOLE PATTERN

PC BOARD THICKNESS:1.6±0.1
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)



NOTES

1. MATERIAL:HOUSING:GLASS FILED THERMO PLASTIC,POLYESTER
CONTACT:COPPER ALLOY
RETENTION LEG:COPPER ALLOY
2. FINISH(CONTACT AREA):0.38μmMIN GOLD PLATING OVER Ni PLATING
3. FINISH(CONTACT AREA):0.76μmMIN GOLD PLATING OVER Ni PLATING
4. FINISH(CONTACT AREA):2.0 μmMIN TIN PLATED OVER NICKEL
~~5. FINISH(RETENTION LEG): TIN-LEAD PLATED (CONTACT TAIL) OVER NICKEL~~
6. FINISH(RETENTION LEG): TIN PLATED (CONTACT TAIL) OVER NICKEL

注記

1. 材料：ハウジング：ガラス入り熱可塑性ポリエステル樹脂
コンタクト：銅合金
リテンションレグ：銅合金
2. めっき：コンタクト：全面Ni下地
接触部：0.38μm MIN金めっき
3. めっき：コンタクト：全面Ni下地
接触部：0.76μm MIN金めっき
4. めっき：コンタクト：全面Ni下地
接触部：2.0 μm MINスズめっき
~~5. めっき：リテンションレグとコンタクト半田付部~~
~~：ニッケル下地の上に半田めっき~~
6. めっき：リテンションレグとコンタクト半田付部
：ニッケル下地の上にスズめっき

KEYING LOCATION 位置	KEYING	HOUSING COLOR	FINISH	PART NO. 製品番号
	Y	BLACK	6 4	2-178313-5
		BLACK	6 3	2-178313-3
		BLACK	6 2	2-178313-2
	X	NATURAL	6 4	6-178313-5
		BLACK	6 4	1-178313-5
		BLACK	6 3	1-178313-3
		BLACK	6 2	1-178313-2

LTR	REVISION RECORD		DR	CHK	DATE
E	REVISED	ECR-06 022713	Y.Y	D.M	25SEP '05
D1	REVISED	ECR-05 017338	TS	D.M	20DEC '05
D	REVISED	FJDO-0039-03	TS	S.M	2.JUN '03
C	REVISED	FJDO-0114-03	TS	S.M	25.APR '03
B	REVISED	FJ00-0838-94	NM	S.M	7/4 '94
A	REDRAWN WITH CHANGE	FJ00-0480-94	NM	S.M	4/20 '94

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WIRE RANGE	INSULATION DIA
mm²(AWG −)	− mmφ
MATERIAL: SEE NOTE 注記参照	FINISH: SEE NOTE 注記参照
DR. 18 JUN 91 N.Matsubara	DE. 18 JUN 91 N.Matsubara
CHK. 20 APR 94 S.MANABE	APP. 20 APR 94 S.MANABE

NAME
3 POS SINGLE ROW
VERTICAL HDR ASS'Y FOR DYNAMIC 3100

一般公差 (GENERAL TOLERANCE)
10以下 ; ±0.3
10を超え 30以下 ; ±0.4
30を超え 100以下 ; ±0.45
角度 ; ±3°

SIZE	LOC	NUMBER
A3	J	C-178313

SCALE	REV.	SHEET
2-1	E	1 OF 1

PRINT DIST

DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT

AMP-J
REV.10/'83

(CUSTOMER DRAWING) 顧客用図面